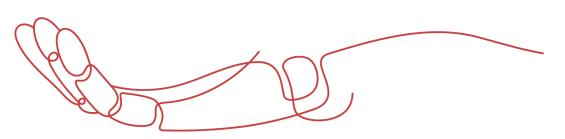




# **PRODUCT DATA SHEET**



To learn more about JGSEMI, please visit our website at







Datasheet

es Samples

Please note: Please check the JINGAO Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.jg-semi.cn. Please email any questions regarding the system integration to JINGAO\_questions@jgsemi.com.



N-Ch 20V Fast Switching MOSFETs

#### **Features**

Ultra low leakage: nA level

• Operating voltage: 8V

Low clamping voltage

Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±30kV

Contact discharge: ±30kV

- IEC61000-4-4 (EFT) 40A (5/50ns)

- IEC61000-4-5 (Lightning) 32A (8/20µs)

RoHS Compliant

## **Applications**

- Cell Phone Handsets andAccessories
- Microprocessor based equipment
- Personal DigitalAssistants(PDA's)
- Notebooks, Desktops, and Servers
- Portable Instrumentation
- Networking and Telecom
- Serial and Parallel Ports
- Peripherals

### **Mechanical Characteristics**

• Package: SOD-323

Lead Finish: Lead Free

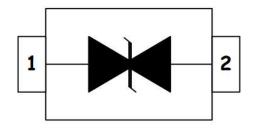
UL Flammability Classification Rating 94V-0

Quantity Per Reel:3,000pcs

Reel Size:7 inch



SOD-323



### Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit	
Peak Pulse Power (8/20µs)	Ррр	600	W	
ESD per IEC 61000-4-2 (Air)	- V <sub>ESD</sub>	± 30	Kv	
ESD per IEC 61000-4-2 (Contact)	VESD	± 30		
Operating Temperature Range	TJ	-55 to +125	$^{\circ}$	
Storage Temperature Range	Тѕтл	-55 to +150	$^{\circ}$ C	



## Electrical Characteristics(TA=25°C unless otherwise specified)

	Device	V <sub>RWM</sub>	$V_{BR}$	Ιτ	Vc	V	C	IR	C
Part Number	Marking	(V)	(V)	(mA)	@1A	(Max)	(@A)	μΑ (Max)	(Pf) (Typ.)
SD08C	2C	8	8.5	1	13.4	18	32	5	120

### **Characteristic Curves**

Fig1. 8/20 µs Pulse Waveform

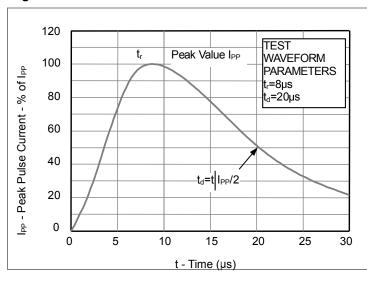


Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)

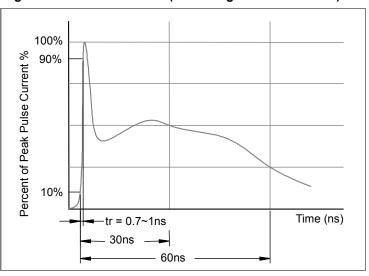
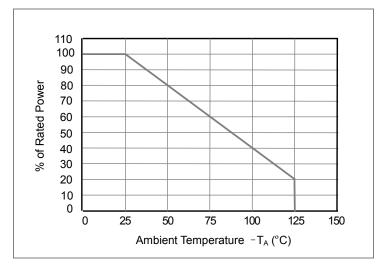
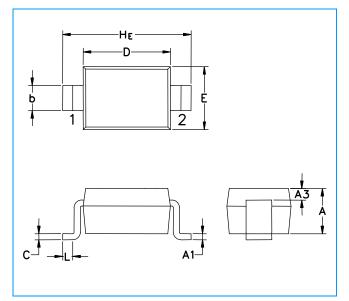


Fig3. Power Derating Curve

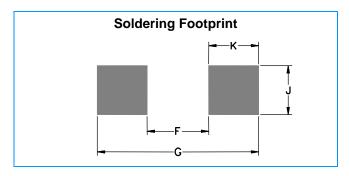




### **SOD-323 Package Outline & Dimensions**



Millimeters			Inches				
Symbol	Min.	Nom.	Max.	Min.	Nom.	Max.	
Α	0.80	0.90	1.15	0.031	0.035	0.045	
A1	0.0.01	0.05	0.15	0.004	0.002	0.006	
А3	0.15 REF			0.006 REF			
b	0.25	0.32	0.45	0.010	0.012	0.018	
С	0.100	0.12	0.150	0.004	0.005	0.006	
D	1.60	1.70	1.95	0.063	0.066	0.077	
E	1.10	1.25	1.50	0.043	0.049	0.059	
L	0.08			0.003			
HE	2.65	2.85	3.10	0.104	0.112	0.122	



Symbol	Millimeters	Inches		
F	1.60	0.063		
<b>G</b> 3.20		0.125		
J	0.60	0.024		
<b>K</b> 0.80		0.031		



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